

|                    |       |
|--------------------|-------|
| $V_{DSS}$          | 30V   |
| $R_{DS(on)}(Max.)$ | 37mΩ  |
| $I_D$              | ±3.5A |
| $P_D$              | 1W    |

## ●Features

- 1) Low on - resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (TSMT3).
- 4) Pb-free lead plating ; RoHS compliant

## ●Application

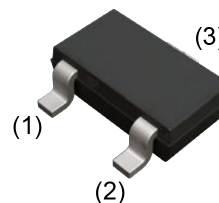
Switching

## ●Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

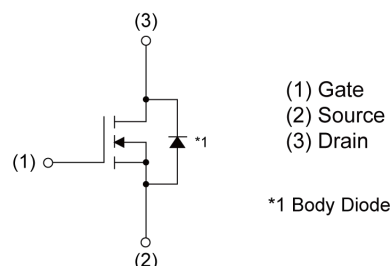
| Parameter                      | Symbol             | Value       | Unit |
|--------------------------------|--------------------|-------------|------|
| Drain - Source voltage         | $V_{DSS}$          | 30          | V    |
| Continuous drain current       | $I_D^{*1}$         | ±3.5        | A    |
| Pulsed drain current           | $I_{D,pulse}^{*2}$ | ±12         | A    |
| Gate - Source voltage          | $V_{GSS}$          | ±20         | V    |
| Avalanche energy, single pulse | $E_{AS}^{*3}$      | 1.9         | mJ   |
| Avalanche current              | $I_{AS}^{*3}$      | 3.5         | A    |
| Power dissipation              | $P_D^{*4}$         | 1           | W    |
| Junction temperature           | $T_j$              | 150         | °C   |
| Range of storage temperature   | $T_{stg}$          | -55 to +150 | °C   |

## ●Outline

TSMT3



## ●Inner circuit



## ●Packaging specifications

| Type | Packing                   | Embossed Tape |
|------|---------------------------|---------------|
|      | Reel size (mm)            | 180           |
|      | Tape width (mm)           | 8             |
|      | Basic ordering unit (pcs) | 3000          |
|      | Taping code               | TCL           |
|      | Marking                   | ZS            |

### ● Thermal resistance

| Parameter                              | Symbol          | Values |      |      | Unit |
|----------------------------------------|-----------------|--------|------|------|------|
|                                        |                 | Min.   | Typ. | Max. |      |
| Thermal resistance, junction - ambient | $R_{thJA}^{*4}$ | -      | 125  | -    | °C/W |

### ● Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

| Parameter                                      | Symbol                                  | Conditions                                      | Values |       |      | Unit  |
|------------------------------------------------|-----------------------------------------|-------------------------------------------------|--------|-------|------|-------|
|                                                |                                         |                                                 | Min.   | Typ.  | Max. |       |
| Drain - Source breakdown voltage               | $V_{(BR)DSS}$                           | $V_{GS} = 0V, I_D = 1mA$                        | 30     | -     | -    | V     |
| Breakdown voltage temperature coefficient      | $\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$ | $I_D = 1mA$<br>referenced to $25^\circ\text{C}$ | -      | 20.84 | -    | mV/°C |
| Zero gate voltage drain current                | $I_{DSS}$                               | $V_{DS} = 30V, V_{GS} = 0V$                     | -      | -     | 1    | μA    |
| Gate - Source leakage current                  | $I_{GSS}$                               | $V_{GS} = \pm 20V, V_{DS} = 0V$                 | -      | -     | ±100 | nA    |
| Gate threshold voltage                         | $V_{GS(th)}$                            | $V_{DS} = V_{GS}, I_D = 1mA$                    | 1.0    | -     | 2.5  | V     |
| Gate threshold voltage temperature coefficient | $\frac{\Delta V_{GS(th)}}{\Delta T_j}$  | $I_D = 1mA$<br>referenced to $25^\circ\text{C}$ | -      | -3.25 | -    | mV/°C |
| Static drain - source on - state resistance    | $R_{DS(on)}^{*5}$                       | $V_{GS} = 10V, I_D = 3.5A$                      | -      | 28    | 37   | mΩ    |
|                                                |                                         | $V_{GS} = 4.5V, I_D = 3.5A$                     | -      | 43    | 56   |       |
| Gate input resistance                          | $R_G$                                   |                                                 | -      | 2.8   | -    | Ω     |
| Transconductance                               | $g_{fs}^{*5}$                           | $V_{DS} = 5V, I_D = 3.5A$                       | 2.4    | -     | -    | S     |

\*1 Limited only by maximum temperature allowed.

\*2  $P_w \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$

\*3  $L \approx 200\mu\text{H}$ ,  $V_{DD} = 15V$ ,  $R_G = 25\Omega$ , STARTING  $T_{ch} = 25^\circ\text{C}$  Fig.3-1,3-2

\*4 Mounted on a ceramic board (30×30×0.8mm)

\*5 Pulsed

**●Electrical characteristics** ( $T_a = 25^\circ\text{C}$ )

| Parameter                    | Symbol            | Conditions                         | Values |      |      | Unit |
|------------------------------|-------------------|------------------------------------|--------|------|------|------|
|                              |                   |                                    | Min.   | Typ. | Max. |      |
| Input capacitance            | $C_{iss}$         | $V_{GS} = 0V$                      | -      | 250  | -    | pF   |
| Output capacitance           | $C_{oss}$         | $V_{DS} = 15V$                     | -      | 40   | -    |      |
| Reverse transfer capacitance | $C_{rss}$         | $f = 1\text{MHz}$                  | -      | 35   | -    |      |
| Turn - on delay time         | $t_{d(on)}^{*5}$  | $V_{DD} \approx 15V, V_{GS} = 10V$ | -      | 5.5  | -    | ns   |
| Rise time                    | $t_r^{*5}$        | $I_D = 1.75A$                      | -      | 7.5  | -    |      |
| Turn - off delay time        | $t_{d(off)}^{*5}$ | $R_L = 8.6\Omega$                  | -      | 10   | -    |      |
| Fall time                    | $t_f^{*5}$        | $R_G = 10\Omega$                   | -      | 3.5  | -    |      |

**●Gate charge characteristics** ( $T_a = 25^\circ\text{C}$ )

| Parameter            | Symbol        | Conditions                           |                 | Values |      |      | Unit |
|----------------------|---------------|--------------------------------------|-----------------|--------|------|------|------|
|                      |               |                                      |                 | Min.   | Typ. | Max. |      |
| Total gate charge    | $Q_g^{*5}$    | $V_{DD} \approx 15V$<br>$I_D = 4.5A$ | $V_{GS} = 10V$  | -      | 6.0  | -    | nC   |
| Gate - Source charge | $Q_{gs}^{*5}$ |                                      | $V_{GS} = 4.5V$ | -      | 3.1  | -    |      |
| Gate - Drain charge  | $Q_{gd}^{*5}$ |                                      |                 | -      | 1.2  | -    |      |
|                      |               |                                      |                 | -      | 1.1  | -    |      |

**●Body diode electrical characteristics** (Source-Drain) ( $T_a = 25^\circ\text{C}$ )

| Parameter                             | Symbol        | Conditions                | Values |      |      | Unit |
|---------------------------------------|---------------|---------------------------|--------|------|------|------|
|                                       |               |                           | Min.   | Typ. | Max. |      |
| Body diode continuous forward current | $I_S^{*1}$    | $T_a = 25^\circ\text{C}$  | -      | -    | 0.8  | A    |
| Body diode pulse current              | $I_{SP}^{*2}$ |                           | -      | -    | 12   |      |
| Forward voltage                       | $V_{SD}^{*5}$ | $V_{GS} = 0V, I_S = 0.8A$ | -      | -    | 1.2  | V    |

# ●Electrical characteristic curves

Fig.1 Typical Output Characteristics(I)

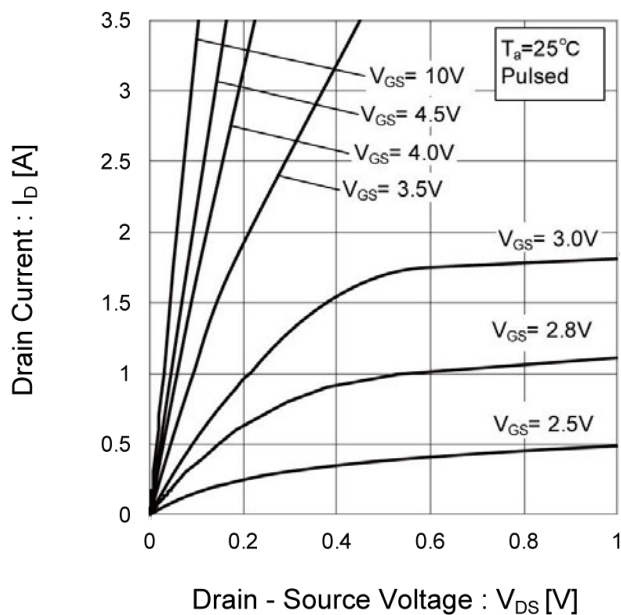


Fig.2 Typical Output Characteristics(II)

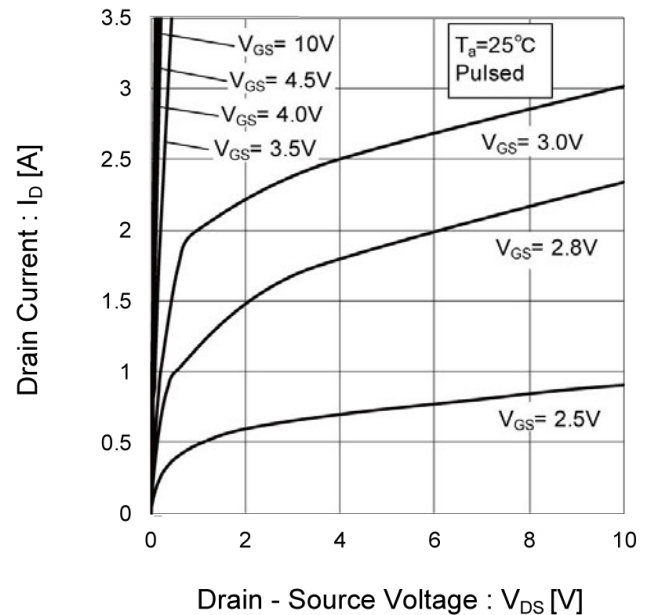
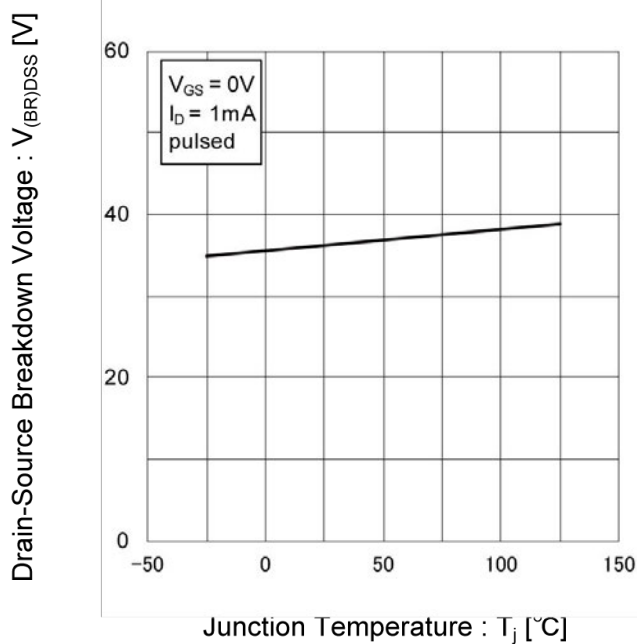


Fig.3 Breakdown Voltage vs. Junction Temperature



## ●Electrical characteristic curves

Fig.4 Typical Transfer Characteristics

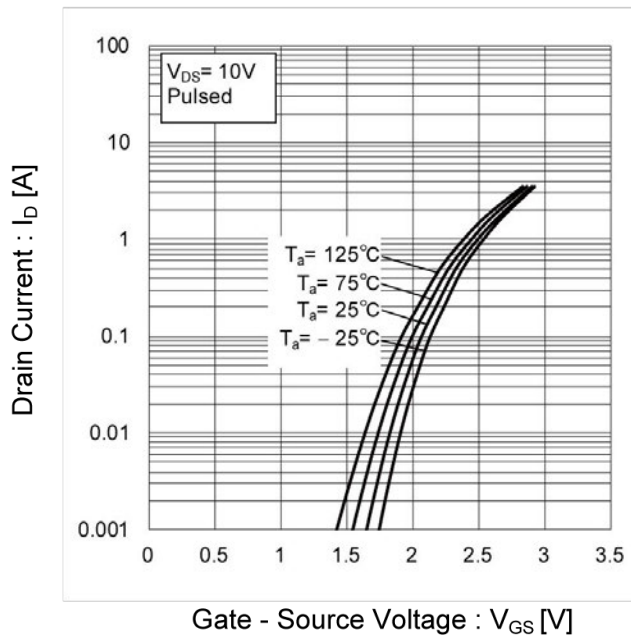


Fig.5 Gate Threshold Voltage vs. Junction Temperature

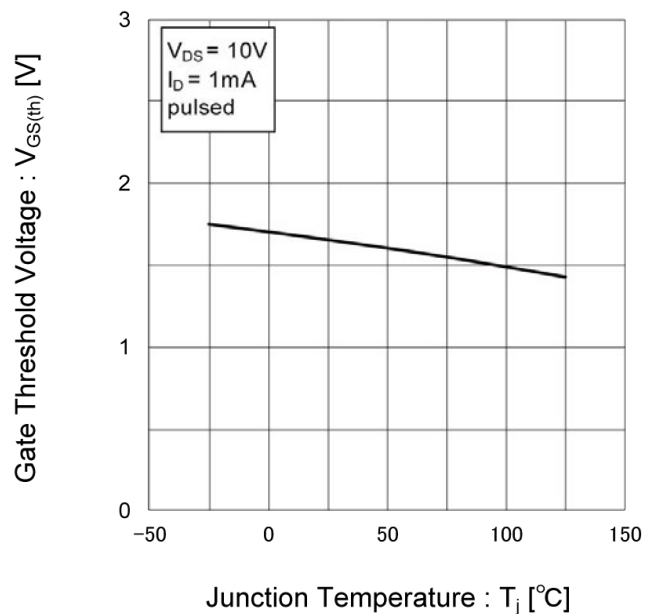
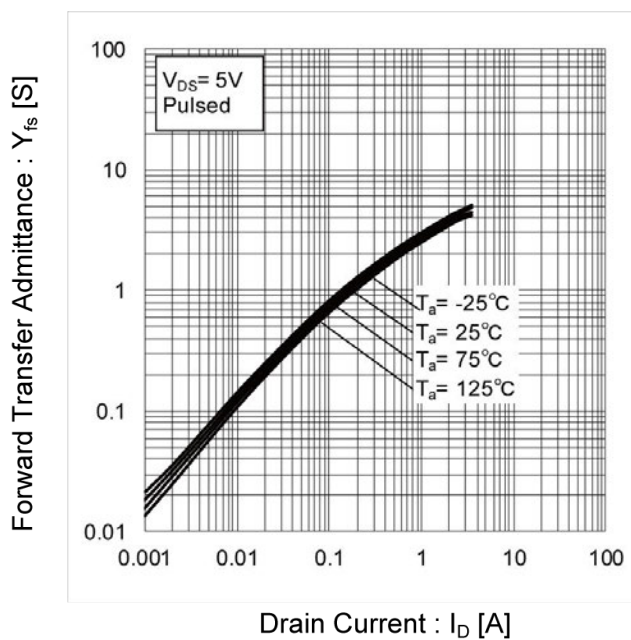


Fig.6 Transconductance vs. Drain Current



# ●Electrical characteristic curves

Fig.7 Drain Current Derating Curve

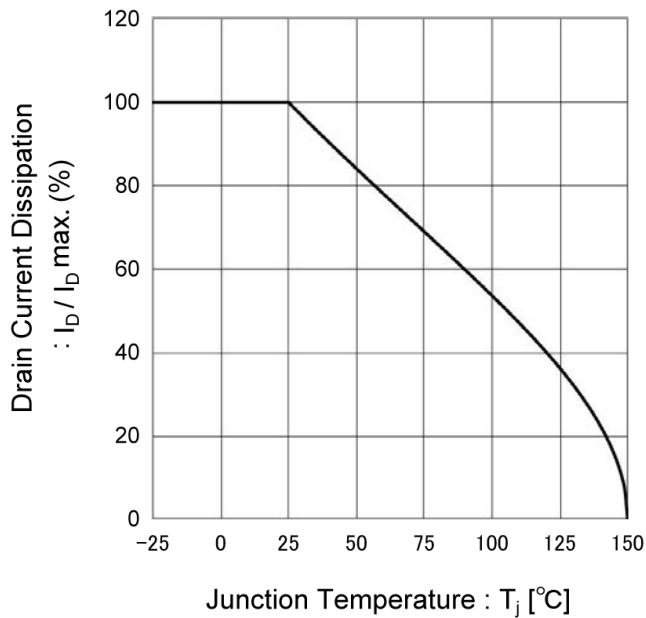


Fig.8 Static Drain - Source On - State Resistance vs. Gate Source Voltage

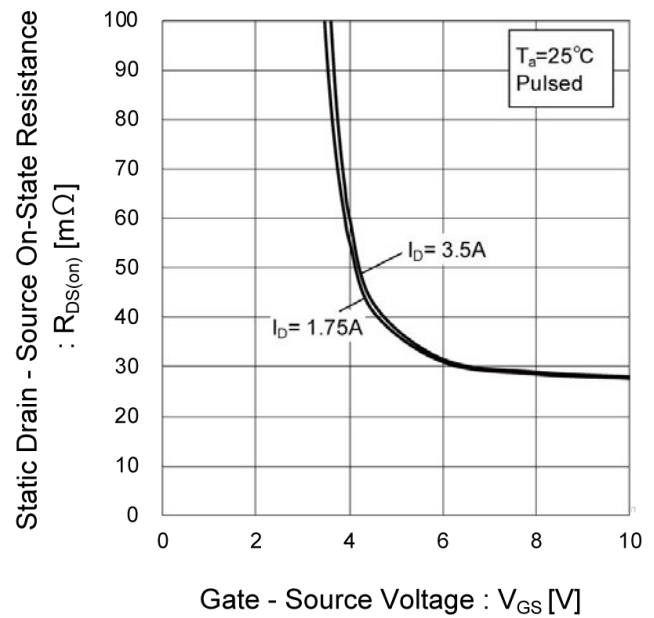
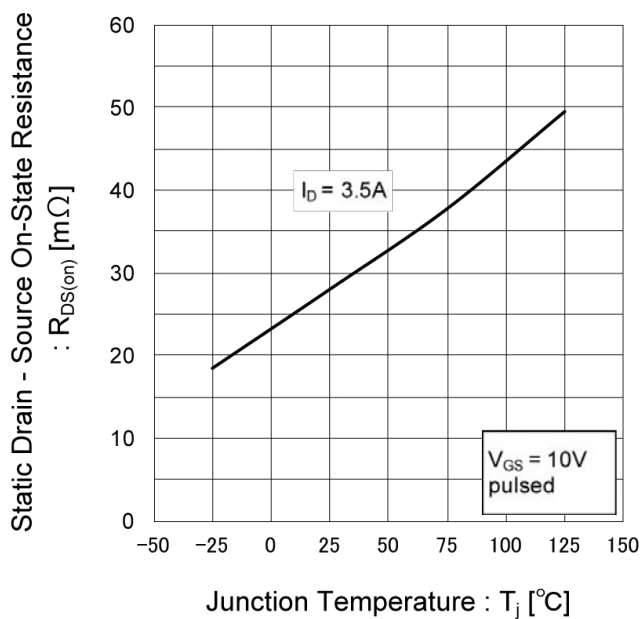


Fig.9 Static Drain - Source On - State Resistance vs. Junction Temperature



# ●Electrical characteristic curves

Fig.10 Static Drain - Source On - State Resistance vs. Drain Current(I)

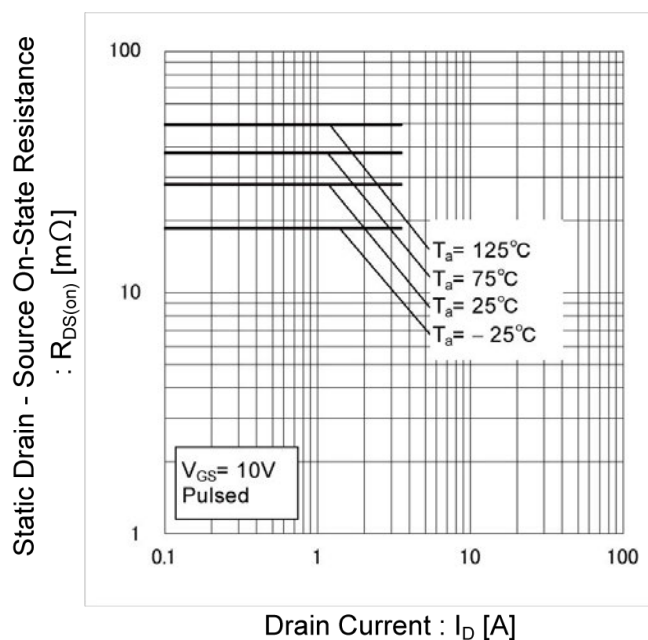
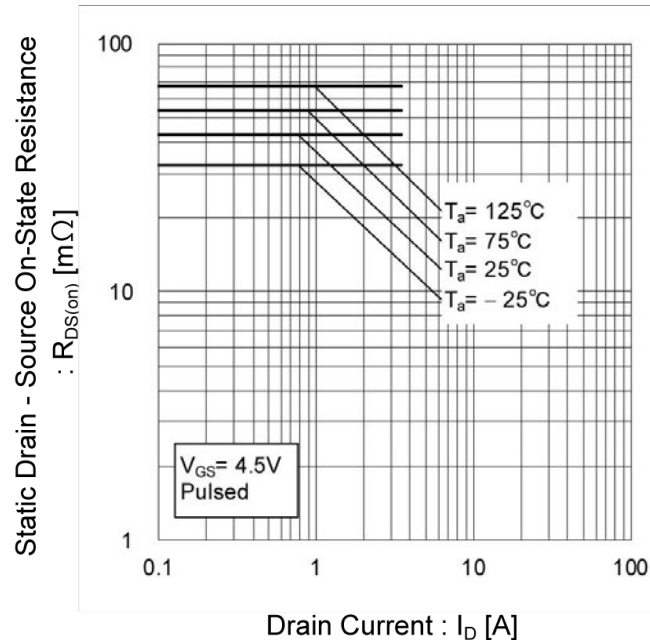


Fig.11 Static Drain - Source On - State Resistance vs. Drain Current(II)



# ●Electrical characteristic curves

Fig.12 Typical Capacitance vs. Drain - Source Voltage

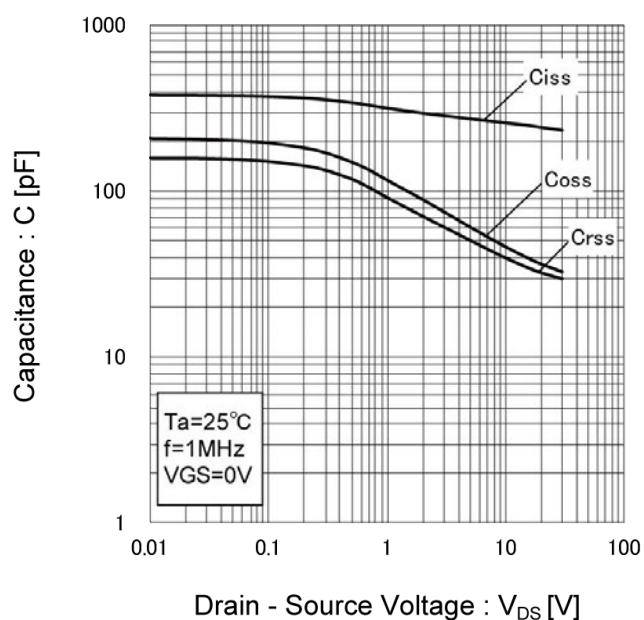
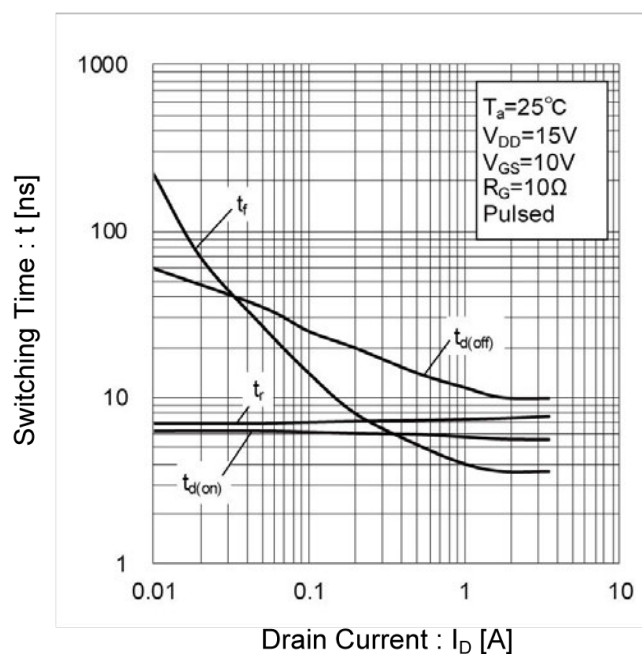


Fig.13 Switching Characteristics



# ●Electrical characteristic curves

Fig.14 Dynamic Input Characteristics

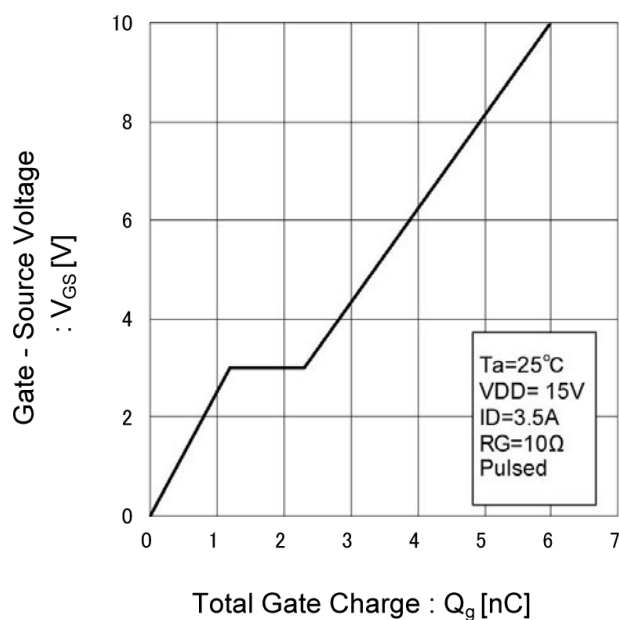
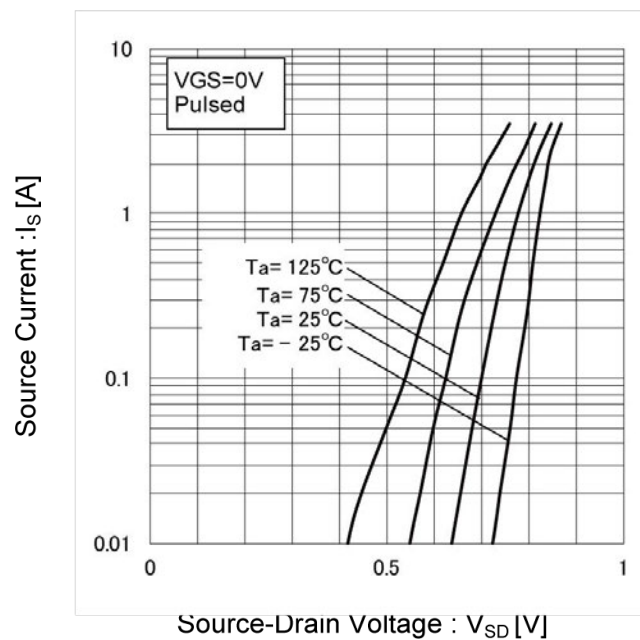


Fig.15 Source Current vs. Source Drain Voltage



## ● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

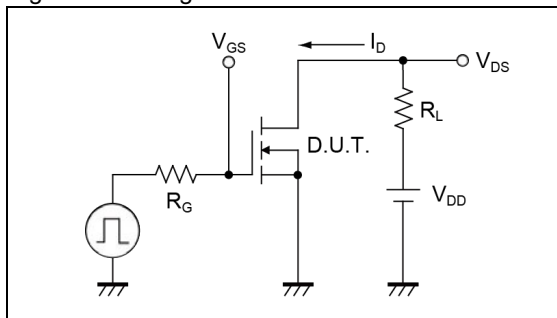


Fig.1-2 Switching Waveforms

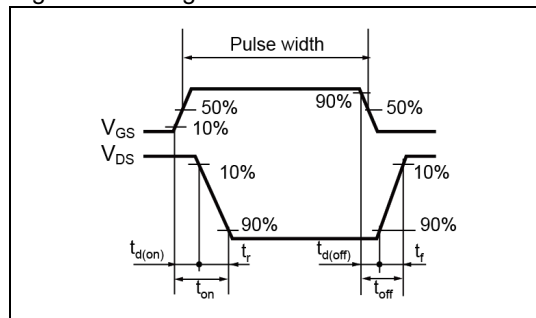


Fig.2-1 Gate Charge Measurement Circuit

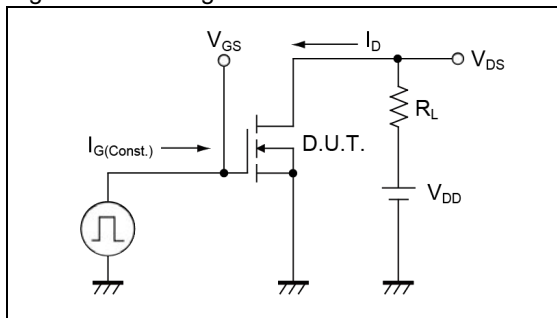


Fig.2-2 Gate Charge Waveform

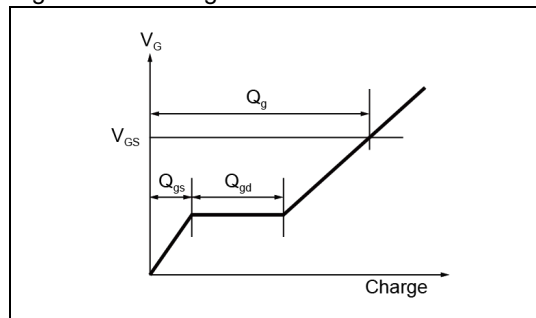


Fig.3-1 AVALANCHE MEASUREMENT CIRCUIT

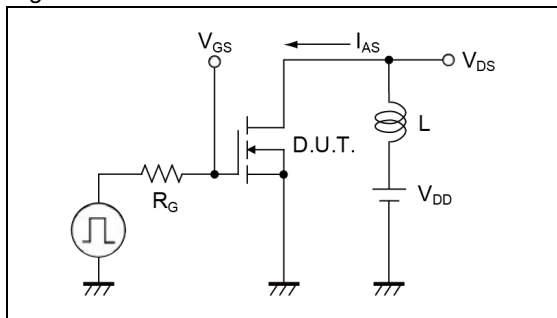
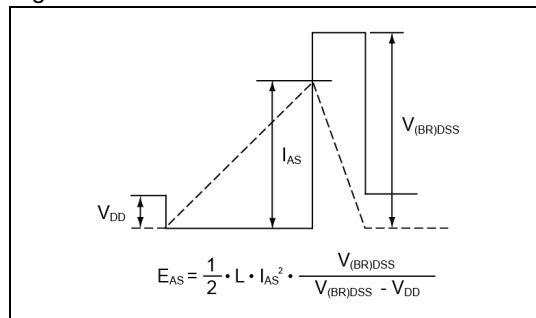
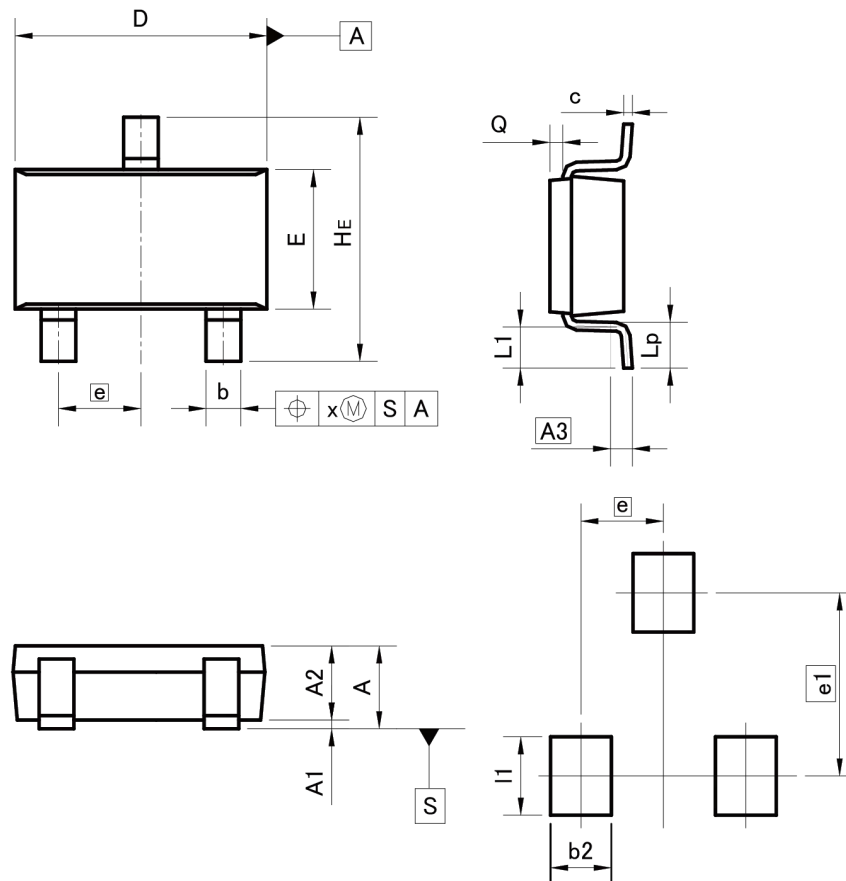


Fig.3-2 AVALANCHE WAVEFORM



## ●Dimensions

TSMT3



Pattern of terminal position areas  
[Not a recommended pattern of soldering pads]

| DIM | MILIMETERS |      | INCHES |       |
|-----|------------|------|--------|-------|
|     | MIN        | MAX  | MIN    | MAX   |
| A   | —          | 1.00 | —      | 0.039 |
| A1  | 0.00       | 0.10 | 0.000  | 0.004 |
| A2  | 0.75       | 0.95 | 0.030  | 0.037 |
| A3  | 0.25       |      | 0.010  |       |
| b   | 0.35       | 0.50 | 0.014  | 0.020 |
| c   | 0.10       | 0.26 | 0.004  | 0.010 |
| D   | 2.80       | 3.00 | 0.110  | 0.118 |
| E   | 1.50       | 1.80 | 0.059  | 0.071 |
| e   | 0.95       |      | 0.037  |       |
| HE  | 2.60       | 3.00 | 0.102  | 0.118 |
| L1  | 0.30       | 0.60 | 0.012  | 0.024 |
| Lp  | 0.40       | 0.70 | 0.016  | 0.028 |
| Q   | 0.05       | 0.25 | 0.002  | 0.010 |
| x   | —          | 0.20 | —      | 0.008 |

| DIM | MILIMETERS |      | INCHES |       |
|-----|------------|------|--------|-------|
|     | MIN        | MAX  | MIN    | MAX   |
| b2  | —          | 0.70 | —      | 0.028 |
| e1  | 2.10       |      | 0.083  |       |
| l1  | —          | 0.90 | —      | 0.035 |

Dimension in mm/inches

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|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV  |           | CLASS III  |           |

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  - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - Sealing or coating our Products with resin or other coating materials
  - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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## Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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